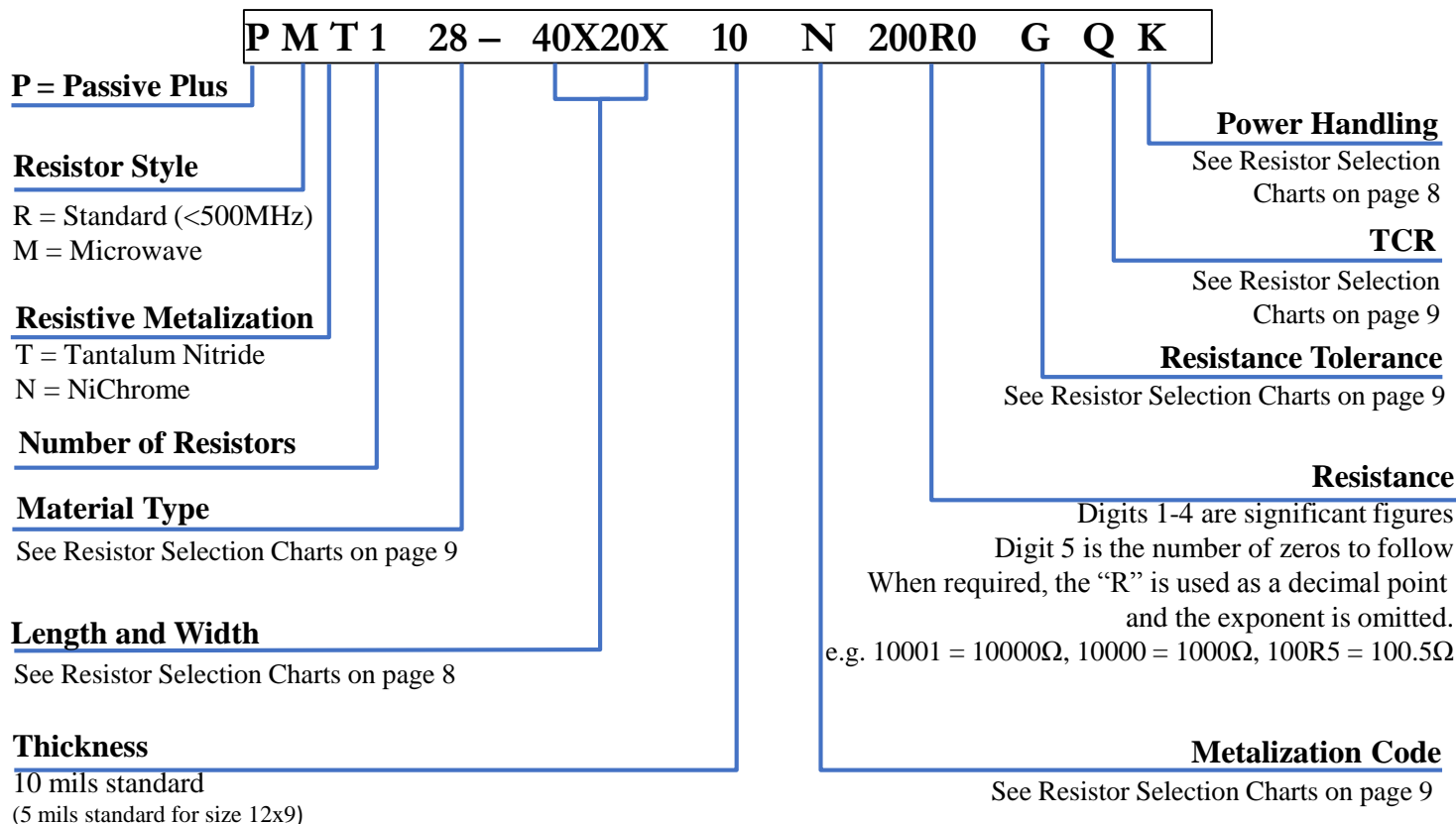


## Part Numbering

Example shown below: Microwave Resistor, TaN resistive element, AlN substrate, case size 0.040" x 0.020" x 0.010", dual edge wrap, resistance 200 Ω ± 2%, 150 ppm TCR, 1.0 W max power handling.



The standard dimensional tolerance for length and width is ± 2 mils.  
The standard dimensional tolerance for thickness is ± 1 mil.

### ◆ Wrap Resistor Bonding Pad Metalizations

Metalization	Application	Code
1 Side Wrap	Epoxy or Au/Sn	H
1 Side Wrap	Epoxy, Au/Sn, or Sn Solder	M
1 Side Wrap	Sn Solder Ball	S
2 Side Wrap	Epoxy or Au/Sn	J
2 Side Wrap	Epoxy, Au/Sn, or Sn Solder	N
2 Side Wrap	Sn Solder Ball	T
Custom	Application-Specific	X